FPC-8100 Series

Robust Box PC with Intel[®] 10th Generation Core[™] i9/i7/i5/i3 Processor

User's Manual

Version 1.0



P/N: 4016810000100P

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Revision History

Version	Release Time	Description
1.0	2021.02	Initial release

Revision History	i
Contentsi	
Preface	,
Copyright Notice	
Declaration of Conformity	/
CE	
FCC Class A	
RoHS	
SVHC / REACHv	-
Important Safety Instructionsvi	
Warning	
Replacing Lithium Batteryvii	i
Technical Support	
Warrantyiv	
Chapter 1 - Introduction1	
1.1. The Computer	
1.2. About this Manual	>
1.3. Specifications	
1.4. Inside the Package6	
1.5.1. Optional Accessories	
1.5.2. Configure-to-Order Service	
Chapter 2 - System Overview	
2.1. Dimensions	
2.2. Take A Tour	
2.2.1. FPC-8100	
2.2.2. FPC-810X	
2.3. Driver Installation Notes	
Chapter 3 - System Configuration	
3.1. Board Layout	
3.2. Jumpers and Connectors	3
3.2.1. Jumpers	
3.2.2. Connectors	
Chapter 4 - Installation and Maintenance	
4.1. Install Hardware	
4.1.1. Open the Computer	
4.1.2. Install CPU	
4.1.3. Install/Uninstall Memory Modules	
4.1.4. Install Wi-Fi Module45	
4.1.5. Install SATA Storage Devices48	
4.1.6. Install PCI and PCI Express Cards (for FPC-810X Only)50	

Contents

4.1.7. Install/uninstall CFast Card5	51
4.1.8. Install/uninstall SIM Card5	52
4.2. Ground the Computer5	
4.3. Wire DC-in Power Source5	
4.3.1 Automation Mode5	55
4.3.2 Vehicle Application Mode5	56
Chapter 5 - BIOS 5	57
5.1. Main6	
5.2. Advanced6	31
5.2.1. CPU Configuration6	32
5.2.2. Trusted Computing6	
5.2.3. ACPI Settings6	
5.2.4. Super IO Configuration6	36
5.2.5. Hardware Monitor6	39
5.2.6. S5 RTC Wake Settings7	70
5.2.7. PCI Sybsystem Settings7	71
5.2.8. USB Configuration7	
5.2.9. CSM Configuration7	74
5.2.10. NVMe Configuration	75
5.3. Chipset	76
5.4. Security	32
5.4.1. Security Boot	33
5.5. Boot	34
5.6. Save & Exit	36
Appendices	37
A: Digital I/O Setting	
B: Watchdog Timer (WDT) Setting	

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This document contains proprietary information protected by copyright. All rights are reserved. No part of this document may be reproduced by any mechanical, electronic, or other means in any form without prior written permission of the manufacturer.

Declaration of Conformity CE

The CE symbol on the computer indicates that it is in compliance with the directives of the Union European (EU). A Certificate of Compliance is available by contacting Technical Support.

This product has passed the CE test for environmental specifications when shielded cables are used for external wiring. We recommend the use of shielded cables. This kind of cable is available from ARBOR. Please contact your local supplier for ordering information.

Warning

This is a class A product. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

FCC Class A

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

NOTE:

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

RoHS

ARBOR Technology Corp. certifies that all components in its products are in compliance and conform to the European Union's Restriction of Use of Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2002/95/EC.

The above mentioned directive was published on 2/13/2003. The main purpose of the directive is to prohibit the use of lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB), and polybrominated diphenyl ethers (PBDE) in electrical and electronic products. Member states of the EU are to enforce by 7/1/2006.

ARBOR Technology Corp. hereby states that the listed products do not contain unintentional additions of lead, mercury, hex chrome, PBB or PBDB that exceed a maximum concentration value of 0.1% by weight or for cadmium exceed 0.01% by weight, per homogenous material. Homogenous material is defined as a substance or mixture of substances with uniform composition (such as solders, resins, plating, etc.). Lead-free solder is used for all terminations (Sn(96-96.5%), Ag(3.0-3.5%) and Cu(0.5%)).

SVHC / REACH

To minimize the environmental impact and take more responsibility to the earth we live, Arbor hereby confirms all products comply with the restriction of SVHC (Substances of Very High Concern) in (EC) 1907/2006 (REACH --Registration, Evaluation, Authorization, and Restriction of Chemicals) regulated by the European Union.

All substances listed in SVHC < 0.1 % by weight (1000 ppm)

Important Safety Instructions

Read these safety instructions carefully

- 1. Read all cautions and warnings on the equipment.
- 2. Place this equipment on a reliable surface when installing. Dropping it or letting it fall may cause damage
- 3. Make sure the correct voltage is connected to the equipment.
- 4. For pluggable equipment, the socket outlet should be near the equipment and should be easily accessible.
- 5. Keep this equipment away from humidity.
- 6. The openings on the enclosure are for air convection and protect the equipment from overheating. DO NOT COVER THE OPENINGS.
- 7. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- 8. Never pour any liquid into opening. This may cause fire or electrical shock.
- 9. Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.
- 10. If one of the following situations arises, get the equipment checked by service personnel:
 - a. The power cord or plug is damaged.
 - b. Liquid has penetrated into the equipment.
 - c. The equipment has been exposed to moisture.
 - d. The equipment does not work well, or you cannot get it to work according to the user's manual.
 - e. The equipment has been dropped or damaged.
 - f. The equipment has obvious signs of breakage.
- 11. Keep this User's Manual for later reference.

Preface

Warning

The Box PC and its components contain very delicately Integrated Circuits (IC). To protect the Box PC and its components against damage caused by static electricity, you should always follow the precautions below when handling it:

- 1. Disconnect your Box PC from the power source when you want to work on the inside.
- 2. Use a grounded wrist strap when handling computer components.
- 3. Place components on a grounded antistatic pad or on the bag that came with the Box PC, whenever components are separated from the system.

Replacing Lithium Battery

Incorrect replacement of the lithium battery may lead to a risk of explosion.

The lithium battery must be replaced with an identical battery or a battery type recommended by the manufacturer.

Do not throw lithium batteries into the trash can. It must be disposed of in accordance with local regulations concerning special waste.

Technical Support

If you have any technical difficulties, please consult the user's manual first at: http://www.arbor-technology.com

Please do not hesitate to e-mail our customer service when you still cannot find out the answer.

E-mail:info@arbor.com.tw

Warranty

This product is warranted to be in good working order for a period of one year from the date of purchase. Should this product fail to be in good working order at any time during this period, we will, at our option, replace or repair it at no additional charge except as set forth in the following terms. This warranty does not apply to products damaged by misuse, modifications, accident or disaster.

Vendor assumes no liability for any damages, lost profits, lost savings or any other incidental or consequential damage resulting from the use, misuse of, or inability to use this product. Vendor will not be liable for any claim made by any other related party.

Vendors disclaim all other warranties, either expressed or implied, including but not limited to implied warranties of merchantability and fitness for a particular purpose, with respect to the hardware, the accompanying product's manual(s) and written materials, and any accompanying hardware. This limited warranty gives you specific legal rights.

Return authorization must be obtained from the vendor before returned merchandise will be accepted. Authorization can be obtained by calling or faxing the vendor and requesting a Return Merchandise Authorization (RMA) number. Returned goods should always be accompanied by a clear problem description.

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Chapter 1 Introduction

1.1. The Computer

- Fanless design
- Wide range DC power input (9~36V)
- HDMI x1 + VGA x 1 and DVI x 1 (support 3 independent displays (W480E, only))
- Power on/off delay control / configurable ignition power control
- TPM2.0 support
- One mPCle for optional WiFi/3G/4G/GPS or I/O expansion supported
- 1 x 2.5 Gigabit LAN support
- 1 x M.2 E Key (2230) for WiFi/BT
- Front-accessible I/O support

1.2. About this Manual



This manual is meant for the experienced users and integrators with hardware knowledge of personal computers. If you are not sure about the description herein, consult your vendor before further handling.

We recommend that you keep one copy of this manual for the quick reference for any necessary maintenance in the future. Thank you for choosing ARBOR products.

1.3. Specifications

System			
CPU	Intel [®] 10 th generation Core™ i9/i7/i5/i3 processor in LGA1200 socket		
Memory 2 x 260-pin DDR4 SO-DIMM sockets, supporting 2 SDRAM up to 64GB			
Chipset	Intel [®] H420E / W480E (Optional)		
Graphics Integrated Intel [®] HD Graphics			
ΑΤΑ	2 x Serial ATA ports with 600MB/s HDD transfer rate		
LAN Chipset 1 x Intel® WGI225LM 2.5GigE LAN 1 x Intel® WGI211AT GbE controllers 1 x Intel® WGI219LM GbE controller (w/o iAMT, H420E) (w/ iAMT, W480E)			
Watchdog Timer 1~255 levels reset			
I/O			
Serial Port	2 x RS-232/422/485 configurable via DB-9 connectors		
Serial Port	4 x RS-232 ports via DB-9 connectors		
USB Port	6 x USB 3.2 Gen1 / 2.0 ports		
USB Port	2 x USB 2.0 ports		
Internal USB dongle (Optional)			
LAN 3 x RJ-45 ports for GbE			
	1 x HDMI		
	1 x DB-15 female connector for Analog RGB		
Video Port	1 x DVI-D female connector for digital video output		
	*Support 2 independent displays *Support 3 independent displays (W480E, only)		
Selectable Port	1 x DB25 connector for DIO (8 in/8 out) port or LPT port (either one, default is DIO)		
Audio Mic-in/Line-out			

Introduction

	1 full-size Mini-card interconnected for optional WiFi/3G/4G/GPS or I/O Expansion	
	1 x SIM socket	
Expansion Bus	1 x M.2 E key (2230) with PClex1+USB2.0, for Wireless	
Expandion Buo	1 x PCle x16 slot +1 x PCl slot (FPC-8101)	
	1 x PCle x16 slot +1 x PCle x8 slot (via x 1 lane) (FPC-8102)	
	2 x PCI (FPC-8103)	
Environmental		
Operating Temp.	-20 ~ 70°C (-4 ~ 158°F), ambient w/ air flow, (w/ 35W TDP CPU, fanless) -20 ~ 50°C (-4 ~ 122°F), ambient w/ air flow (w/ 65W TDP CPU, fan less)	
Storage Temp.	-40 ~ 85°C (-40 ~ 185°F)	
Operating Humidity	10 ~ 95% @ 70°C (non-condensing)	
Vibration 3 Grms/5~500Hz/random operation w/ SSD		
Shock Operating 40G (11ms), Non-operating 60G with SSD		
Qualification		
Certification	CE, FCC Class A	
Power Requirement	t	
Power Input	DC 9~36V input (w/ 4-pin DC input terminal block,combining remote power on/off switch	
Ignition Switch 2-pin teminal block: IGN, GND		
Power Consumption	MAX 65W (w/35W TDP CPU, w/o I/O card) MAX 95W (w/65W TDP CPU, w/o I/O card)	
Storage		
Туре	2 x 2.5" drive bays	
Type	1 x CFast socket, can be outside accessible	
Mechanical		
Construction	nstruction Aluminum alloy	
Mounting	Wall-mount	
Weight 6.4kg (14.11lb)(FPC-8100) 7kg (15.43lb)(FPC-810X)		
Dimensions (W x H x D)	225 x 292 x 90 mm (8.86" x 11.50" x 3.54") for FPC-8100 225 x 292 x 120mm (8.86" x 11.50" x 4.72") for FPC-8101/8102/8103	

OS Support

Windows 10 IOT Enterprise 64-bit Linux (Kernel:4.9) Introduction

1.4. Inside the Package

Upon opening the package, carefully inspect the contents. If any of the items is missing or appears damaged, contact your local dealer or distributor. The package should contain the following items:



1.5.1. Optional Accessories

The following items are normally optional, but some vendors may include them as a standard package, or some vendors may not carry all the items.

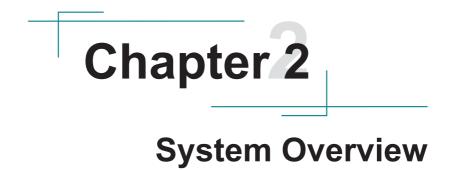


1.5.2. Configure-to-Order Service

Make the computer more tailored to your needs by selecting one or more components from the list below to be fabricated to the computer.

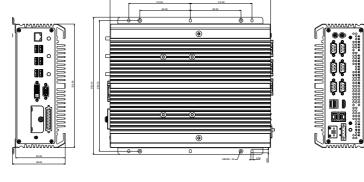
Introduction

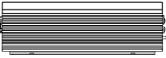
240GB SSD	Intel® 2.5" 240GB SATAIII SSD kit	
WIFI-AT4550	Atheros QCNFA324 Wi-Fi module w/ 20&30cm internal wires	-
ANT-H11	1 x 2dBi HSUPA antenna	1
ANT-D11	1 x WiFi dual-band 2.4G/5G antenna	1
Core™ i9-10900E	Intel® 10th Gen. Core™ i9-10900E processor, L2/20M, 2.8G	
Core™ i9-10900TE	Intel® 10th Gen. Core™ i9-10900TE processor, L2/20M, 1.8G	
Core™ i7-10700E	Intel® 10th Gen. Core™ i7-10700E processor, L2/16M, 2.9G	
Core™ i7-10700TE	Intel® 10th Gen. Core™ i7-10700TE processor, L2/16M, 2.0G	(intel)
Core™ i5-10500E	Intel® 10th Gen. Core $^{\rm TM}$ i5-10500E processor, L2/12M, 3.1G	(interv
Core™ i5-10500TE	Intel® 10th Gen. Core™ i5-10500TE processor, L2/12M, 2.3G	
Core™ i3-10100E	Intel® 10th Gen. Core™ i3-10100E processor, L2/6M, 3.2G	
Core™ i3-10100TE	Intel® 10th Gen. Core™ i3-10100TE processor, L2/6M, 2.3G	
MK-4C- 4G/8G/16G/32G	DDR4-2400 4GB/8GB/16GB/32G SDRAM DIMM kit	L. D
FAN-4020	Fan kit (40 x 40 x 20 mm, L=250mm, 2P)	



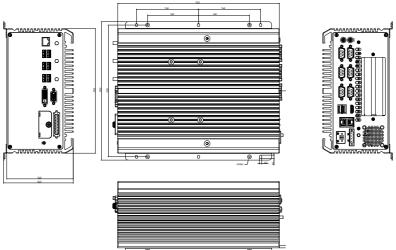
2.1. Dimensions

FPC-8100



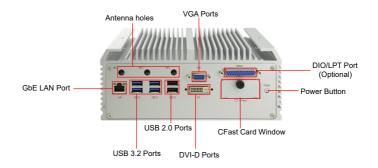


FPC-810X

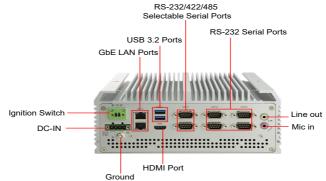


System Overview

- 2.2. Take A Tour
- 2.2.1. FPC-8100
- 2.2.1.1 Front View

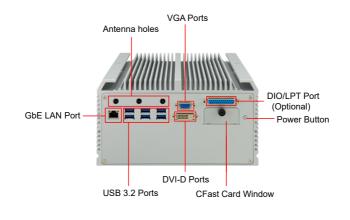


2.2.1.2 Rear View

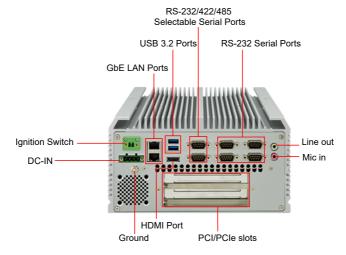


2.2.2. FPC-810X

2.2.2.1 Front View



2.2.2.2 Rear View



2.3. Driver Installation Notes

The CPU module supports Windows 10 64-bit and Linux. To install the drivers, please go to our website at **www.arbor-technology.com** and download the driver pack from the product page. Then extract the downloaded file and follow the sequence below to install the drivers:

$\textbf{Chipset} \rightarrow \textbf{Graphic} \rightarrow \textbf{Audio} \rightarrow \textbf{Other drivers}$

The driver path is listed as below:

Driver	Path	
Chipset	\WIN10\Chipset\10.1.1.42\SetupChipset.exe	
LAN	\WIN10\Ethernet\PROWinx64.exe	
VGA	\WIN10\Graphics\Setup.exe	
Audio	\WIN10\AUDIO\0006-64bit_Win7_Win8_Win81_Win10_R279.exe	
ME	\WIN10\ME_11.6\SetupME.exe	

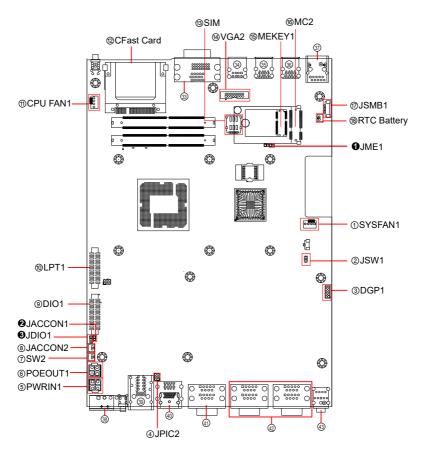
Chapter 3

System Configuration

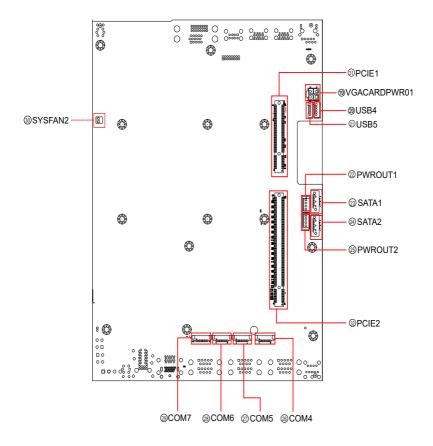
Engine of the Computer

3.1. Board Layout

Board Top



Board Bottom



Engine of the Computer

Jumpers

Label	Description
1 JME1	Clear CMOS selection
2JACCON1	ACC ON Mode selection
	Ignition power mode
Connectors	
Label	Description
①SYSFAN1	Fan power connector
②JSW1	System reset pin header
③DGP1	External 80 port pin header
④JPIC2	Vcore IC debug pin header
5PWRIN1	DC adapter power input
6POEOUT1	PoE power connector
⑦SW2	System switch
⑧JACCON2	Ignition Power connector
③DIO1	Digital IO Connector
10LPT1	On-board parallel port connector
1 CPUFAN1	Fan power connector
12CF1	CFast Card type slot
13SIM	Nano SIM card socket
14VGA2	Analog RGB
15MEKEY1	M.2 E-Key socket
16MC2	PCI Express Mini-card socket
⑦JSMB1	SMbus wafer connector
18 RTC Battery	RTC Battery
19VGACARDPWR1	Power output for VGA card
20 20 USB4,5	USB wafer connector
@@pwrout1,2	SATA HDD power connector

3 SATA1, SATA2	Serial ATA connector
28 20 COM4, COM5	RS232 connector
28 29 COM6, COM7	RS232/RS422/RS485 connector
30 SYSFAN2	Fan power connector
³ PCIE1	PCI Expansion Slot
³² PCIE2	PCI Expansion Slot
³³ VGA1	Analog RGB & DVI-D connector
343530USB1, 2, 3	USB 2.0/3.0 connectors
③LAN1	RJ-45 Ethernet connector
³⁸ PWRIN3	DC Adapter Power Input
39LAN2	Dual GbE RJ-45 Ethernet connectors
40 HDMISUB1	HDMI + USB Connector
41COM1/2	RS-232/422/485 Selectable Serial Port
⁽⁴²⁾ COM3/4, 5/6	RS-232
43Audio1	Audio connector

Engine of the Computer

3.2. Jumpers and Connectors

3.2.1. Jumpers

1 JME1

Function: Jumper Type: Setting:	nper Type: 2.00mm pitch, 1x2-pin header		
	Short Clear	CMOS	1 2
	Open Keep	CMOS (default)	1002
2 JACCON1			
Function: ACC ON Mode selection(for debug) Jumper Type: 2.00mm pitch, 1x2-pin header Setting: Pin Description			
	Open Carm	node	1002
Function:Digital I/O VCC out put voltageJumper Type:Onboard 2.00mm-pitch 1x3-pin headerSetting:PinDescription			
	Short 1-2	12V	1.
	Short 2-3	5V (default)	1.

3.2.2. Connectors

11 FAN Connector (SYSFAN1/CPUFAN1)

Function: Fan Power Connector

Connector Type: Onbard 2.54mm pitch 1x4-pin one-wall wafer connector

Pin Assignment: Pin Description

1	GND	_ ■ 1
2	+12V	
3	RPM	4
4	Control	-

② System reset pin header (JSW1)

Function: Reserv	ed for Reset button
------------------	---------------------

Connector Type: onboard 2.0mm pitch 2-pin header

Pin Assignment:

Pin	Description	<u> </u>	
1	FR_RST#		
2	GND	2	1

③ DGP1						
Function:	External 80 port					
Connector Type:	2.00m	nm-pitch 2x5-pin	header			
Pin Assignment:	Pin	Description	Pin	Description		
	1	CLK	2	GND	00	
	3	FRAME#	4	LAD0		
	5	PLTRST#	6	N.C		
	7	LAD3	8	LAD2	2001	
	9	VCC3	10	LAD1		

Engine of the Computer

④ Vcore IC debug pin header (JPIC2)

5

Function	Reserved For Vcore IC debug			
Connector Type:	Onboard 2.0mm pitch 6-pin header			
Pin Assignment:	Pin	Description		
	1	NC	2	NC
	3	GND	4	PMSCL

OC OC 2|0 🗆

⑤ PWRIN1

Function

DC-IN Power Connector Connector Type: 2.54mm-pitch 4-pin header

nPMALERT

6

PMSDA

Pin Assignment:

Pin Description

1	GND	1	
2	GND		
3	DCIN		
4	DCIN	3	

⑥ POEOUT1

Function: Connector Type: **Pin Assignment:**

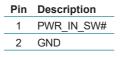
PoE Power Connector			
2.54mm-pitch 4-pin header			

Pin	Desc.	
1	GND	
2	GND	
3	DCIN	
4	DCIN	_

⑦ SW2

Function Connector Type: **Pin Assignment:**







⑧ JACCON2

Function Connector Type: Pin Assignment: Ignition Power Connector Onboard 2x1-pin box connector

Pin Description

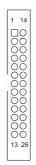
1 Acc_ON 2 GND



③ DIO1

Function: Connector Type: Pin Assignment:

Digital IO Connector 2.0mm pitch 2x13 pin box header			
Pin	besc.	Pin	Desc
1	DIO0	14	DIO8
2	DIO1	15	DIO9
3	DIO2	16	DIO10
4	DIO3	17	DIO11
5	DIO4	18	DIO12
6	DIO5	19	DIO13
7	DIO6	20	DIO14
8	DIO7	21	DIO15
9	+5V	22	GND
10	+5V	23	GND
11	N.C	24	N.C
12	N.C	25	N.C
13	N.C	26	N.C



Engine of the Computer

1 LPT1

Function: Pin Assignment:

On-board Parallel Port Connector **Connector Type:** 2.00mm pitch 2 x13-pin box header

Pin	Desc.	Pin	Desc.
1	STB#	14	AFD#
2	PD0	15	ERR#
3	PD1	16	INIT#
4	PD2	17	SLIN#
5	PD3	18	GND
6	PD4	19	GND
7	PD5	20	GND
8	PD6	21	GND
9	PD7	22	GND
10	ACK#	23	GND
11	BUSY	24	GND
12	PE	25	GND
13	SLCT	26	N.C

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12 CF1

Function: Connector Type:	7+17-	∙pin signal (Card cor		onsisting of a SATA compat- ⁷ -pin power and control
Pin Assignment:	Pin	Desc.	Pin	Desc	
	S1	SGND1	PC6	TBD	
	S2	TXP	PC7	GND	
	S3	TXN	PC8	LED1	
	S4	SGND2	PC9	LED2	
	S5	RXN	PC10	IO1	
	S6	RXP	PC11	102	- PC1
	S7	SGND	PC12	103	
	PC1	CDI	PC13	3.3V	
	PC2	GND	PC14	3.3V	
	PC3	TBD	PC15	GND	
	PC4	TBD	PC16	GND	
	PC5	TBD	PC17	CD0	
 SIM Function: Connector Type: Pin Assignment: 	6-pin SI	rd Socket M card soc Desc. P i		c	

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Engine of the Computer

WGA2

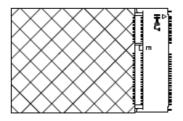
Function: Connector Type:	Analog RGB Analog RGB(D-Sub 15-pin female type)				
Pin Assignment:	Pin	Desc.	Pin	Desc.	
	1	RED	9	+5V	
	2	GREEN	10	GND	
	3	BLUE	11	N/C	
	4	N/C	12	VDDAT	
	5	GND	13	HSYNC	
	6	GND	14	VSYNC	
	7	GND	15	VDCLK	
	8	GND			

(5) MEKEY1

Pin Assignment:

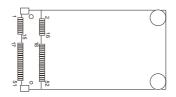
Function:

M.2 E-Key socket (w/ PCIe + USB 2.0) for optional Wi-Fi/BT Connector Type: M.2 E-Key 2230 Socket The pin assignments conform to the industry standard.



16 MC2

Function:PCI Express Mini-card Full sockedConnector Type:Onboard 0.8mm pitch 52-pin edge card connector.Pin Assignment:Image: Connector C



⑦ SMBUS Connector(JSMB1)

Function:SConnector Type:1Pin Assignment:

SMbus Wafer connector for DIO
1.25mm pitch 1x6 wafer connector

Pin	Desc.
1	+V3.3S
2	GND
3	CLK
4	GND
5	DATA
6	+V12S



18 BAT1

Function: Connector Type: Pin Assignment:

RTC E	Battery	
Onboa	ard 2x1-pin box co	onnector
Pin	Desc.	
1	BAT+	10
2	BAT-	

Engine of the Computer

19 VGACARDPWR1

Function: Connector Type:	VGA card power oboard 2.54mm pitch 4-pin wafer				
Pin Assignment:	Pin	Desc.			
	1	GND			
	2	GND			
	3	+V12S			
	4	+V12S			



2021 USB4, 5

Function: Pin Assignment:

USB 3.0/2.0 Connectors Connector Type: On-board 1.25mm pitch 1x5 pin wafer connector

Pin	Description.	
1	+5V	
2	D-	1
3	D+	
4	GND	
5	GND	_

2 B PWROUT1, 2

SATA HDD Power Connector

Connector Type: 2.54mm pitch 4x7-pin one-wall connector Pin Assignment:

Function:

Pin Description

Description.		
+5V	1	
GND		
GND	4	ŏ
+12V		
	+5V GND GND	+5V 1 GND GND 4

23 2 SATA1, 2

Function: Serial ATA Connector On-board Stabdard 7-pin Serial ATA Connector Connector Type: Pin Assignment: Pin Description 1 GND 2 TX+ 3 TX-4 GND 5 RX-6 RX+ 7 GND

26 27 COM4, 5

Function: Pin Assignment:

RS232 Connector(COM4~COM5) Connector Type: Onboard 1.25mm pitch 9-pin Connector

Pin	Description	
1	XDCD#	
2	XDSR#	
3	XRXD	
4	XRTS#	
5	XTXD	
6	XCTS#	
7	XDTR#	
8	XRI#	
9	GND	

ACES	ľ		8	8	8	ij	Ø	Ø		
		Ψ	Ψ	Ψ	Ψ		Ψ	Ψ	ų	<u> </u>

Engine of the Computer

28 29 COM6, 7 Function:

Pin Assignment:

RS232 Connector(COM6~COM7) Connector Type: Onboard 1.25mm pitch 9-pin Connector

Pin	Description
1	XDCD#
2	XDSR#
3	XRXD
4	XRTS#
5	XTXD
6	XCTS#
7	XDTR#
8	XRI#
9	GND

³⁰ SYSFAN2

Function: S Connector Type: 2 Pin Assignment:

System Fan power out	
2.0mm-pitch 2-pin header	

Pin	Description	
1	+12V	
2	GND	

s conform to the industry standard.
s conform to the industry standard.

³³ VGA1

Function:	
Connector	Туре:

Analog RGB & DVI-D Connector Analog RGB (D-Sub 15-pin female type) + DVI-D (DVI-D female connector)



Pin Assignment:

Analog RGB Connector

Pin	Desc.	Pin	Desc.	Pin	Desc.
1	RED	6	GND	11	N/C
2	GREEN	7	GND	12	VDDAT
3	BLUE	8	GND	13	HSYNC
4	N/C	9	+5V	14	VSYNC
5	GND	10	GND	15	VDCLK

DVI-D Connector

Pin	Desc.	Pin	Desc.	Pin	Desc.
1	TMDS Data 2-	9	TMDS Data 1-	17	TMDS Data 0-
2	TMDS Data 2+	10	TMDS Data 1+	18	TMDS Data 0+
3	GND	11	GND	19	GND
4	NC	12	NC	20	NC
5	NC	13	NC	21	NC
6	DDC clock	14	+5V	22	GND
7	DDC data	15	GND	23	TMDS clock+
8	NC	16	Hot plug detect	24	TMDS clock-

343536 USB1, 2, 3

Function:	USB 2.0/3.0 connectors
Connector Type:	USB2.0/3.0 Type-A connectors
Pin Assignment:	The Pin assignment conform to the industry standard.

Engine of the Computer

^③ LAN1	
Function:	RJ-45 Ethernet connector
Connector Type:	RJ-45 connector that supports 10/100/1000Mbps fast Ethernet
Pin Assignment:	The Pin assignment conform to the industry standard.

³⁸ PWRIN3

Function: Connector Type:		pter Power Input erminal block	
Pin Assignment:	Pin	Desc.	1 2 3 4
	1	VIN+	
	2	VIN-	
	3	Switch -	
	4	Switch +	

³⁹ LAN2

Function:	Dual GbE RJ-45 Ethernet connectors
Connector Type:	RJ-45 connector that supports
	10/100/1000Mbps fast Ethernet
Pin Assignment:	The Pin assignment conform to the industry
	standard.





(1) HDMIUSB1

Function:	HDMI Connectors (includes USB Connectors)
Connector Type:	HDMI + double stacked USB type A connector
Pin Assignment:	The Pin assignment conform to the industry standard.







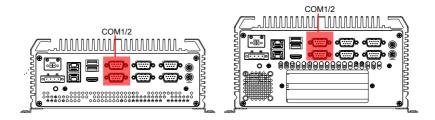
(4) COM1 (Panel label: COM1/2)

 Function:
 RS-232/422/485 Selectable Serial Port

 Connector Type:
 External double-stacked 9-pin D-sub male connector

 Pin Assignment:
 External double-stacked 9-pin D-sub male connector

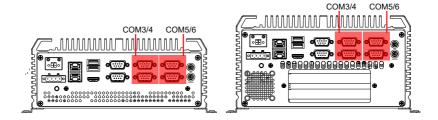
	Pin	Desc.	Pin	Desc.	
	1	DCD / (RS422 TX-) / (RS485-)	6	DSR	
RS-232	2	RXD / (RS422 TX+) / (RS485+)	7	RTS	
110-232	3	TXD / (RS422 RX+)	8	CTS	
	4	DTR / (RS422 RX-)	9	RI	
	5	GND			
	1	COM_422 TX-			
	1	COM_422 TX+			_
RS-422	2	COM_422 RX+			
	3	COM_422 RX-			
	4	GND			-
	1	COM_485 D-			-
RS-485	2	COM_485 D+			-
	5	GND			-



Engine of the Computer

(42) COM2,3 (Panel label: COM3/4, COM5/6)

Function: Connector Type:		32 Serial Port nal double-stacke	ed 9-pin	D-sub male con	nector
Pin Assignment:	Pin	Description	Pin	Description	
	1	DCD	6	DSR	
	2	RXD	7	RTS	
	3	TXD	8	CTS	
	4	DTR	9	RI	
	5	GND			



(43) Audio1 Function:

Audio connector

Connector Type: Pin Assignment: Double-stacked ø3.5mm stereo audio jacks



Chapter 4

Installation and Maintenance

4.1. Install Hardware

The FPC-8100 Series is constructed based on modular design to make it easy for users to add hardware or to maintain the computer. The following sections will guide you to the simple hardware installations for the computer.

4.1.1. Open the Computer

For the computer, removing the top and bottom covers is essential to open the computer and access the inside. Follow through the steps below to remove the top cover and bottom cover from the computer.

4.1.1.2. Remove Top Cover

All jumpers, CPU socket, MiniCard socket, SDRAM SO-DIMM slots, DIO/ LPT ports are built on the top side of the main board. To access these components, the computer's top cover has to be removed. Follow through the steps below to remove the top cover.

FPC-8100

1. Place the computer on a flat surface. Loosen and remove the 6 screws as shown below.



2. Loosen and remove the 4 screws on the front and rear panels respectively as shown below.



3. Carefully lift the top cover and then completely part the top cover from the computer.



The inside of the computer comes to view.



FPC-810X

1. Place the computer on a flat surface. Loosen and remove the 4 screws as shown below.



2. Loosen and remove the 2 screws on the front and rear panels respectively as shown below.



3. Carefully lift the top cover and then completely part the top cover from the computer.



The inside of the computer comes to view.



4.1.1.3. Remove the Bottom Cover

The Serial ATA connectors, the power connectors for SATA storage devices, and the internal USB ports, PCI/PCIe slots are all built on the bottom side of the main board. To access these connectors, the computer's bottom cover has to be removed. Follow through the steps below to remove the bottom cover from the computer.

FPC-8100

- 1. Remove the top cover as desribed in <u>4.1.1.2. Remove Top Cover on page</u> <u>34.</u>
- 2. Lift and remove the main board assembly and you can access the bottom side of the main board.



FPC-810X

1. Place the computer upside down on a flat surface. Loosen and remove the 2 screws on the bottom side of front and rear panels respectively as shown below.



2. After removing the screws, carefully lift and remove the bottom cover from the computer.



The bottom of the computer comes to view.

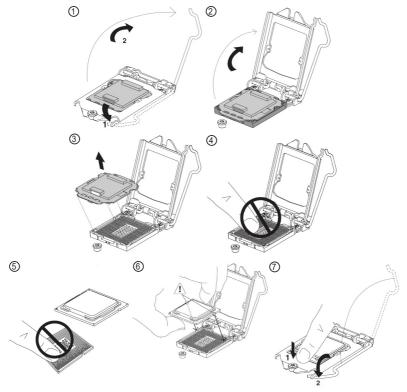


4.1.2. Install CPU

- 1. Remove the top cover from the computer as described in <u>4.1.1.2. Remove</u> <u>Top Cover on page 34.</u>
- 2. Locate the CPU socket on the main board



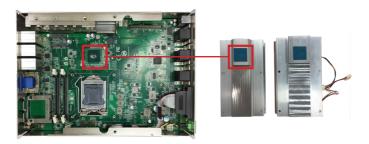
The processor socket comes with a lever to secure the processor. Please refer to the pictures step by step as below and note that the cover of the socket must always be installed during transportation to avoid damage to the socket.



3. Find the heat sink in the accessory box. Attach the thermal pad to the heatsink, and remove the blue release liner.



- 4. Apply the thermal paste to the CPU.
- 5. Place the heat sink on the CPU and PCH. Make sure that the thermal pad is in complete contact with the PCH chipset and the heat sink is in complete contact with the CPU to avoid overheating problem. If not, it would cause your system or CPU hanged, unstable or damaged.

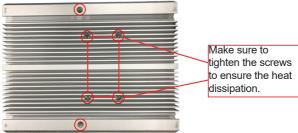


6. Secure the heat sink with 6 screws.



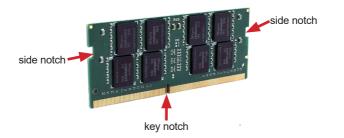
Heat sink for fanless models

7. Restore the top cover to the computer by fastening the 6 screws as shown below. Note that the 4 screws in the middle are used to secure the top cover to the heat sink. Make sure they are tightened to ensure the heat dissipation.



4.1.3. Install/Uninstall Memory Modules

The main board has two memory module (DIMM) sockets. Increase memory capacity to make programs run faster on the system. The memory module for the FPC-8100 Series' SO-DIMM sockets should be a 260-pin DDR4 with a "key notch" off the centre among the pins, which enables the memory module for particular applications. There are another two notches at each left and right side of the memory module to help fix the module in the socket.



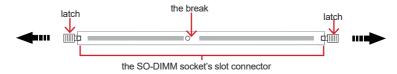
To install a DDR4 memory module:

- 1. Remove the top cover from the computer as described in <u>4.1.1.2. Remove</u> <u>Top Cover on page 34.</u>
- 2. Locate the SO-DIMM sockets on the main board.



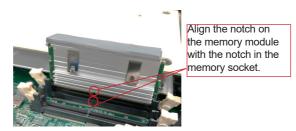
The SO-DIMM sockets are vertical type, and each socket has two latches for fixing the memory modules. The memory module can only be installed by one direction due to the notch.

3. Pull back both latches from the socket.



vertical-type SO-DIMM socket (overview)

4. Confront the memory module's edge connector side at the SO-DIMM socket. Position the memory module at the SO-DIMM socket, with the memory module's key notch aligned at the break of the SO-DIMM's slot connector.



5. Vertically plug the memory module to the DIMM socket. "Fully" plug the memory module until both latches auto-lock the memory module in place.



6. Restore the top cover to the computer.

To uninstall a DDR4 memory module:

1. Pull back both latches from the SO-DIMM socket.

The DDR4 memory module will be auto-released from the socket.



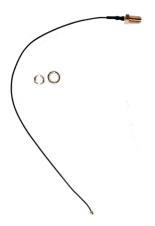
- 2. Remove the memory module.
- 3. Restore the top cover to the computer.

4.1.4. Install Wi-Fi Module

- 1. Remove the top cover from the computer as described in <u>4.1.1.2. Remove</u> <u>Top Cover on page 34.</u>
- 2. Locate the M.2 E-Key socket for wireless module.



3. Prepare the Wi-Fi module kit. The module is a **M.2 E-Key** socket form factor, with two U.FL connectors, one is "MAIN", and the other is "AUX".



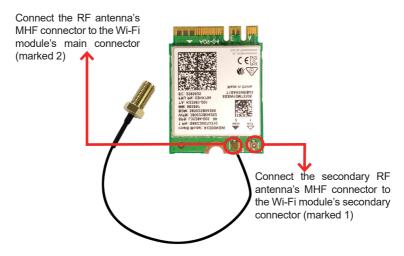
Two U.FL connectors, one is "MAIN" (marked 2), the other is "AUX" (marked 1).



4. Have the RF antenna. The antenna has an SMA connector on one end

and an MHF connector on the other.

5. Connect the RF antenna's MHF connector to the Wi-Fi module's main connector marked 0. If you are going to connect a secondary antenna, connect it to the connector marked 1.



6. Plug the Wi-Fi module to the socket's connector by a slanted angle. Fully plug the module, and note the notch on the wireless module should meet the break of the connector.



7. Press the module down and fix the module in place using one screw.



8. Locate the SMA antenna holes on front panel. Remove the plastic plug to make an antenna hole. Keep the plastic plug for any possible restoration in the future.



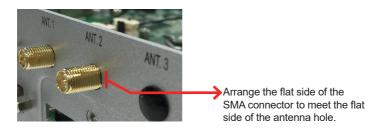




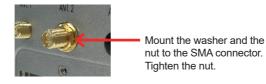
9. From the other end of the RF antenna, which is an SMA connector, remove the washer and the nut. Note the SMA connector has the form of a threaded bolt, with one flat side.



10. Pull the SMA connector through the above mentioned antenna hole. Note to meet the aforesaid flattened side with the antenna hole's flat side.



11. Mount the washer first and then the nut to the SMA connector. Make sure the nut is tightened.



12. Have the external antenna(s). Screw and tightly fasten the antenna(s) to the SMA connector.



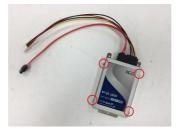
4.1.5. Install SATA Storage Devices

4.1.5.1. Install Internal SATA Storage Device

1. Remove the bottom cover from the computer as described in <u>4.1.1.3.</u> <u>Remove the Bottom Cover on page 37.</u> 2. Find the HDD/SSD brackets inside the computer. Loosen and remove the screws as marked in the illustration below. Then dismount the brackets from the computer.



3. Attached the SATA cable to the HDD/SSD storage device. Slide the HDD/SSD storage device into the bracket and fix the storage device in place by fastening the 2 screws on both sides of the bracket.



4. Install the bracket with the storage device back into the computer by refastening the 3 screws.



5. Connect the SATA signal cable and power cable.



power cable



signal cable

6. Restore the bottom cover to the computer.

4.1.6. Install PCI and PCI Express Cards (for FPC-810X Only)

To install a PCI or PCI Express card:

- 1. Remove the bottom cover from the computer as described in <u>Section</u> <u>4.1.1.3. Remove the Bottom Cover on page 37.</u>
- 2. Use a cross head screwdriver to loose the screw that secure the expansion slot bracket. And then you can install a PCIe card to this expansion slot.



3. Restore the bottom cover to the computer.

4.1.7. Install/uninstall CFast Card

The computer supports a CFast card for storage and comes with an outsideaccessible CFast slot. Follow through the guide below to install a CFast card to the computer. (This section will use FPC-810X as the installation example.)



Note: Be sure to turn off the computer before installing or uninstalling the CF card if the OS is installed on the card.

To install the CFast card:

1. From the front panel of the computer, find the door to the CFast slot. Loosen and remove the screw that locks the door.



2. Once the screw is removed, open the door. The CFast slot then comes to view.



3. Position the CFast card as directed by the graphic printed on the front panel. Insert the CFast card all the way into the slot.

To uninstall the CFast card:

- 1. Loosen and remove the card door screw and open the card door.
- 2. Push-eject the CFast card.
- 3. Remove the CFast card.
- 4. Refasten the screw to close the card door.

Note: Make sure to refasten the screw to close the card door each time the CFast card is installed or uninstalled.

4.1.8. Install/uninstall SIM Card

This section will use FPC-810X as the example to guide you through the SIM card installation steps:

- 1. Remove the top cover from the computer as described in <u>4.1.1.2. Remove</u> <u>Top Cover on page 34.</u>
- 2. Locate the SIM card slot on the main board.



3. Slide the SIM card holder cover towards the OPEN edge and then lift the cover to open it.



4. Insert the SIM card into the card holder as shown below.



5. Close the SIM card holder door and slide the door to the LOCK edge to lock into place.



To uninstall the SIM card:

- 1. Loosen and remove the card door screw and open the card door.
- 2. Push-eject the SIM card.
- 3. Remove the SIM card.
- 4. Refasten the screw to close the card door.

Note: Make sure to refasten the screw to close the card door each time the SIM card is installed or uninstalled.

4.2. Ground the Computer

Follow the instructions below to ground the computer to land. Be sure to follow every grounding requirement in your place.

Warning Whenever the unit is installed, the ground connection must always be made first of all and disconnected lastly.

- 1. See the illustration below. Remove the ground screw from the rear panel.
- 2. Attach a ground wire to the rear panel with the screw.





FPC-810X

4.3. Wire DC-in Power Source

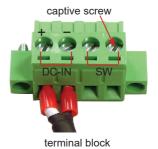
4.3.1 Automation Mode

Follow the instructions below for connecting the computer to a DC-input power source.

Warning Only trained and qualified personnel are allowed to install or replace this equipment.

- 1. Before wiring, make sure the power source is disconnected.
- 2. Find the terminal block in the accessory box.
- 3. Use the wire-stripping tool to strip a short insulation segment from the output wires of the DC power source.
- 4. Identify the positive and negative feed positions for the terminal block connection. See the symbols printed on the rear panel indicating the polarities and DC-input power range in voltage.
- 5. Insert the exposed wires into the terminal block plugs. Only wires with insulation should extend from the terminal block plugs. Note that the polarities between the wires and the terminal block plugs must be positive to positive and negative to negative.
- 6. Use a slotted screwdriver to tighten the captive screws. Plug the terminal block firmly, which wired, into the receptacle on the rear panel.



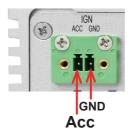


- 55 -

4.3.2 Vehicle Application Mode

Follow the instructions below for connecting the computer to a vehicle power source.

- 1. Make sure JACCON2 jumper is open for vehicle power mode. (Refer to <u>Section 3.2.1. Jumpers on page 18)</u>.
- 2. For vehicle application, DC power Input wiring pin configuration is as below. Please connect the Acc pin with your car Acc, and the device will be activated when you turn your ignition key to Acc.





BIOS

The BIOS Setup utility for the FPC-8100 Series is featured by American Megatrends Inc to configure the system settings stored in the system's BIOS ROM. The BIOS is activated once the computer powers on. When the computer is off, the battery on the main board supplies power to BIOS RAM.

To enter the BIOS Setup utility, keep hitting the "Delete" key upon powering on the computer.

Main Advanced Chipset	Aptio Setup – AMI Security Boot Save & Exit	
BIOS Name BIOS Version Build Date and Time Access Level ME FW Version System Date System Time	FPC-810X 1.00 01/25/2021 11:15:09 Administrator 14.0.37.1165 [Sat 02/20/2021] [15:59:29]	Set the Date. Use Tab to switch between Date elements. Default Ranges: Year: 1938-3939 Months: 1-12 Days: Dependent on month Range of Years may vary. ++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F10: Save & Exit ESC: Exit
	Version 2.21.1278 Copyright (C) 202	1 AMI

The featured settings are:

Menu	Description	
Main	See <u>5.1. Main on page 60</u>	
Advanced	See 5.2. Advanced on page 61	
Chipset	See 5.3. Chipset on page 76	
Security	See 5.4 Security on page 82	
Boot	See <u>5.5. Boot on page 84</u>	
Save & Exit	See 5.6. Save & Exit on page 86	

Key Commands

The BIOS Setup utility relies on a keyboard to receive user's instructions. Hit the following keys to navigate within the utility and use the utility.

Keystroke	Function	
$\leftarrow \rightarrow$	Moves left/right between the top menus.	
↓↑	Moves up/down between highlight items.	
Enter	Selects an highlighted item/field.	
Esc	 On the top menus: Use Esc to quit the utility without saving changes to CMOS. (The screen will prompt a message asking you to select OK or Cancel to exit discarding changes. On the submenus: Use Esc to quit current screen and return to the top menu. 	
Page Up / +	Increases current value to the next higher value or switches between available options.	
Page Down / -	Decreases current value to the next lower value or switches between available options.	
F1	Opens the Help of the BIOS Setup utility.	
F2	Previous values	
F9	Optimized defaults	
F10	Exits the utility saving the changes that have been made. (The screen then prompts a message asking you to select OK or Cancel to exit saving changes.)	

Note: Pay attention to the "WARNING" that shows at the left pane onscreen when making any change to the BIOS settings.

This BIOS Setup utility is updated from time to time to improve system performance and hence the screenshots hereinafter may not fully comply with what you actually have onscreen. BIOS

5.1. Main

The **Main** menu features the settings of **System Date** and **System Time** and displays some BIOS info.

Main Advanced Chipset Se	Aptio Setup – AMI curity Boot Save & Exit	
BIOS Name BIOS Version Build Date and Time Access Level ME FW Version System Date System Time	FPC-810X 1.00 01/25/2021 11:15:09 Administrator 14.0.37.1165 [Sat 02/20/2021] [15:59:29]	Set the Date. Use Tab to switch between Date elements. Default Ranges: Year: 1998–9999 Months: 1–12 Days: Dependent on month Range of Years may vary.
		++: Select Screen f1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
	/ersion 2.21.1278 Copyright (C) 2	021 AMI

The featured settings are:

Setting	Description	
System Date	 Set the system date. Use Tab to switch between Data elements. Note that the 'Day' automatically changes when you set the date. The date format is: Day: Sun to Sat Month: 1 to 12 Date: 1 to 31 Year: 1998 to 2099 	
System Time	 Set the system time. Use Tab to switch between Time elements. The time format is: Hour: 00 to 23 Minute: 00 to 59 Second: 00 to 59 	

5.2. Advanced

Main Advanced Chipset	Aptio Setup – AMI Security Boot Save & Exit	
 CPU Configuration Trusted Computing ACPI Settings Super IO Configuration Hardware Monitor SS RTC Hake Settings PCI Subsystem Settings USB Configuration CSM Configuration NVMe Configuration 		CPU Configuration Parameters
		++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
	Version 2.21.1278 Copyright (C)	2021 AMI

The featured settings and submenus are:

Setting	Description
CPU Configuration	See 5.2.1. CPU Configuration on page 62
Trusted Computing	See 5.2.2. Trusted Computing on page 64
ACPI Settings	See 5.2.3. ACPI Settings on page 65
Super IO Configuration	See 5.2.4. Super IO Configuration on page 66
Hardware Monitor	See 5.2.5. Hardware Monitor on page 69
SS RTC Wake Settings	See 5.2.6. S5 RTC Wake Settings on page 70
PCI Subsystem Settings	See 5.2.7. PCI Sybsystem Settings on page 71
USB Configuration	See 5.2.8. USB Configuration on page 72
CSM Configuration	See 5.2.9. CSM Configuration on page 74
NVMe Configuration	See 5.2.10. NVMe Configuration on page 75

5.2.1. CPU Configuration

Advanced	Aptio Setup – AMI	
CPU Configuration		Number of cores to enable in
Type ID Speed L1 Data Cache L1 Instruction Cache L2 Cache L3 Cache	Intel(R) Core(TM) 17-10700TE CPU @ 2.00GHz 0xA0655 2000 HHz 32 KB x 8 32 KB x 8 256 KB x 8 16 MB	each processor package.
Active Processor Cores Hyper-Threading Intel (VMX) Virtualization Technology Intel(R) SpeedStep(tm) Turbo Mode C states	[A11] [Enabled] [Enabled] [Disabled] [Disabled] [Disabled]	<pre>++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit</pre>
Versi	on 2.21.1278 Copyright (C) 202:	1 AMI

Setting	Description		
Active Processor Cores	Number of cores to enable in each processor package. Options: All (default) and 1		
Hyper-Threading	Enabled (default) for Windows XP and Linux (OS optimized for Hyper-Threading Technology) and Disabled for other OS (OS not optimized or Hyper-Threading Technology). When disabled only one thread per enabled core is enabled.		
Intel (VMX) Virtualization Technology	When enabled, a VMM can utilize the additional hardware capabilities provided by Vanderpool Technology. Options: Enabled (default) or Disabled 		
Intel (R) Speed Step (tm)	Enable (default)/Disable Intel SpeedStep. Allows more than two frequency ranges to be supported.		
Turbo Mode	Only available when Intel Speed Step is Enabled . Enable /Disable (default) Turbo Mode (requires EMTTM enabled, unless max turbo ratio is bigger than 16 - SKLAO W/A.		

	Enable /Disable (default) CPU power management.
C States	Allows CPU to go to C state when it's not 100% utilized.

5.2.2. Trusted Computing

Advanced	Aptio Setup – AMI	I
TFM 2.0 Device Found Firmware Version: Vendor: Security Device Support Pending operation	5.62 IFX [Enable] [None]	Enables or Disables BIOS support for security device. O.S. will not show Security Device. TCG EFI protocol and INTIA interface will not be available. ++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Vens	ion 2.21.1278 Copyright	(C) 2021 AMI

Setting	Description
Security Device Support	Enable (default) or Disable BIOS support for security device.
Pending operation	Schedule an Operation for the security Device. Your computer will reboot during restart in order to change State of Security Device. Options: None (default) and TPM Clear

5.2.3. ACPI Settings

Advanced	Aptio Setup – AMI	
ACPI Settings		Enables or Disables BIOS ACPI Auto Configuration.
Enable ACPI Auto Configuration		nato con iga ation.
Enable Hibernation ACPI Sleep State	[Enabled] [S3 (Suspend to RAM)]	
		++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Version	2.21.1278 Copyright (C) 202	21 AMI

Setting	Description
Enable ACPI Auto Configuration	Enables or Disables (default) BIOS ACPI Auto Configuration
Enable Hibernation	Enables (default) or Disables System ability to Hibernate (OS/S4 Sleep State). This option may be not effective with some OS.
ACPI Sleep State	 Select ACPI sleep state the system will enter when the SUSPEND button is pressed. Options: Suspend Disabled and S3 (Suspend to RAM) (default)

5.2.4. Super IO Configuration

Advanced	Aptio Setup – AMI	
Super IO Configuration		Set Parameters of Serial Port 1 (COMA)
Super IO Chip > Serial Port 1 Configuration > Serial Port 2 Configuration > Parallel Port Configuration	F81866	
Super IO Chip > Serial Port 1 Configuration > Serial Port 2 Configuration > Serial Port 3 Configuration > Serial Port 4 Configuration	F81216SEC	
		++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Versio	n 2.21.1278 Copyright (C) 20	21 AMI

Super IO Chip F81866 Settings

Setting	Description	
Serial Port Configuration		
Serial Port	Enable (default) or Disable Serial Port (COM).	
Mode Select	Select RS-232 (default), RS-422, RS-485, RS-422 Termination Resistor or RS-485 Termination Resistor	
Parallel Port Configuration		
Parallel Port	Enable (default) or Disable Parallel Port (LPT/LPTE).	

Device Mode	Change the printer port mode: Options: STD Printer Mode (default); SPP Mode; EPP-1.9 and SPP Mode; EPP-1.7 and SPP Mode; ECP Mode; ECP and EPP 1.9 Mode; ECP and EPP 1.7 Mode
-------------	---

Super IO Chip F81216SEC Settings

Serial Port Configuration	
Serial Port Enable (default) or Disable Serial Port (COM).	

5.2.5. Hardware Monitor

Advanced	Aptio Setup — AMI	
Pc Health Status Pc Health Status SYSFAN SmartFan Function CPU temperature System temperature CPUFAN Speed SYSFAN Speed Vcore +3.3V + 5V + 12V VcC3V VSB3V VSB5V VBAT	: +31 % : +36 % : N/A : N/A : +0.872 V : +3.264 V : +5.087 V : +12.144 V : +3.328 V : +3.312 V : +3.312 V : +3.104 V	Smart Fan function setting ++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
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The features settings are:

Setting	Description	
CPUFAN SmartFan Function	Enables (default) or Disables Smart Fan	
	Boundary 1~4 & Segment Speed 1~5	
SYSFAN SmartFan Function	Auto fan speed control. Fan speed will follow different temperature by different PRM 1-100.	

Note: CPUFAN & SYSFAN functions only apply to SKUs with smart fan. If your SKU doesn't come with smart fan, ignore these settings.

5.2.6. S5 RTC Wake Settings

Advanced	Aptio Setup – AMI	
Wake system from S5	[Disabled]	Enable or disable System wake on alarm event. Select FixedTime, system will wake on the hr::min::sec specified. Select DynamicTime , System will wake on the current time + Increase minute(s) +: Select Screen 14: Select Screen Enter: Select
		+/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
V	ersion 2.21.1278 Copyright ((C) 2021 AMI

Setting	Description	
Wake System	 Enable or Disable (default) system wake on alarm event. Options available are:	
from S5	Disabled (default): Fixed Time: System will wake on the hr::min::sec specifiedc. DynamicTime: If selected, you need to set Wake up minute increase from 1 - 5. System will wake on the current time + increase minute(s).	

5.2.7. PCI Sybsystem Settings

Advanced	Aptio Setup – AMI	
PCI Bus Driver Version	A5.01.19	Value to be programmed into PCI Latency Timer Register.
PCI Devices Common Settings: PDI Latency Timer PCI-X Latency Timer Above 4G Decoding	[32 PCI Bus Clocks] [64 PCI Bus Clocks] [Disabled]	
		++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Versio	n 2.21.1278 Copyright (C) 2	021 AMI

Setting	Description	
PCI Latency Timer	 Value to be programmed into PCI Latency Timer Register. Options: 32 (default), 64, 96, 128, 160, 192, 224 and 248 PCI Bus Clocks. 	
PCI-X Latency Timer	 Value to be programmed into PCI-X Latency Timer Register. Options: 32, 64 (default), 96, 128, 160, 192, 224 and 248 PCI Bus Clocks. 	
Above 4G Decoding	Enable/Disable (default) 64bit capable Devices to be Decoded in Above 4G Address Space (Only if System Supports 64 bit PCI Decoding).	

5.2.8. USB Configuration

Advanced	Aptio Setup – AMI	
USB Configuration		Enables Legacy USB support. AUTO option disables legacy
USB Module Version	24	support if no USB devices are connected. DISABLE option will
USB Controllers: 1 XHCI		keep USB devices available only for EFI applications.
USB Devices: 1 Drive, 1 Keyboard, 1 Hub		
Legacy USB Support	[Enabled]	
XHCI Hand-off	[Enabled]	
USB hardware delays and time-outs:	fox 1	
USB transfer time-out Device reset time-out	[20 sec] [20 sec]	↔: Select Screen 1↓: Select Item
Device power-up delay	[Auto]	Fnter: Select
bevice power-up derag	[hd(0]	+/-: Change Opt.
Mass Storage Devices:		F1: General Help
KingstonDataTraveler 3.0PMAP	[Auto]	F2: Previous Values
		F9: Optimized Defaults
		F10: Save & Exit
		ESC: Exit
Version 2	2.21.1278 Copyright (C) 2021.	AMI

Setting	Description	
	 Enables/disables legacy USB support. Options available are Enabled (default), Disabled and Auto. 	
Legacy USB Support	 Select Auto to disable legacy support if no USB device are connected. 	
	 Select Disabled to keep USB devices available only for EFI applications. 	
XHCI Hand-off	This is a workaround for OSes without XHCI hand-off support. The XHCI ownership change should be claimed by XHCI driver. The optional settings are: Enabled (default) / Disabled .	
USB Transfer time- out	Use this item to set the time-out value for control, bulk, and interrupt transfers. ► Options: 1 sec, 5 sec, 10 sec, 20 sec (default).	

Device reset time- out	 Use this item to set USB mass storage device start unit command time-out. ▶ Options available are: 10 sec, 20 sec (default)., 30 sec, 40 sec
Device power-up delay	 Use this item to set maximum time the device will take before it properly reports itself to the host controller. 'Auto' uses default value: for a root port it is 100 ms, for a hub port the delay is taken from hub descriptor. Options available are: Auto: Default Manual: Select Manual you can set value for the following sub-item: 'Device Power-up delay in seconds', the delay range in from 1 to 40 seconds, in one second increments.

5.2.9. CSM Configuration

Advanced	Aptio Setup – AMI	
Compatibility Support Module Configu	ration	Enable/Disable CSM Support.
CSM Support		
CSM16 Module Version	07.84	
Boot option filter Option ROM execution	[UEFI and Legacy]	
Network Storage Video Other PCI devices	[Do not launch] [Legacy] [Legacy] [Legacy]	++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Version 2	.21.1278 Copyright (C) 2021	AMI

Setting	Description	
CSM Support	Enable (default) or Disable CSM Support.	
Boot option filter	 Control the Legacy/UEFI ROMs priority. Options: UEFI and Legacy (default), Legacy only and UEFI only 	
Network	Control the execution of UEFI and Legacy PXE OpROM Options: Do not launch (default), UEFI and Legacy	
Storage	Control the execution of UEFI and Legacy Storage OpROM Options: Do not launch and Legacy (default)	
Video	Control the execution of UEFI and Legacy Video OpROM ► Options: UEFI and Legacy (default)	
Other PCI devices	Determines OpROM execution policy for devices other than network, storage or video ► Options: Do not launch and Legacy (default)	

5.2.10. NVMe Configuration



Access this submenu to view the NVMe controller and driver information.

5.3. Chipset

The Chipset menu controls the system's chipset.



Setting	Description		
System Agent (SA) Configuration			
Memory Configuration	Access this submenu to view the memory configuration.		
Graphics Configuration	See 5.3.1.1. Graphics Configuration on page 78		
PEG Port Configuration	 PEG port options Enable Root Port: Enable or Disable the root port. Options: Auto (default), Enabled and Disabled. 		
	 Max Link Speed: Configure PEG 0:1:0 Max Speed. Options: Auto (default), Gen1, Gen 2 and Gen3. 		
VT-d	Enable (default) or Disable VT-d function		

Above 4GB MMIO BIOS assignment	Enable or Disable (default) Above 4GB MMIO BIOS assignment. This is enabled automatically when aperture size is set to 2048MB.	
PCH-IO Configuration		
SATA And RST Configuration	on See <u>5.3.1.2. SATA And RST Configuration on page</u>	
USB Configuration	See 5.3.1.3. USB Configuration on page 81	
State After G3	 Specify what state to go to when power is re-applied after a power failure (G3 state). Options available are Power On (default), Power Off and Last State. 	

5.3.1.1. Graphics Configuration

Ap	tio Setup Utility - Chipset	Copyright (C)	2017 American	Megatrends, Inc.
Graphics Configur Primary Display Internal Graphic GTT Size Aperture Size DVMT Pre-Allocat DVMT Total Gfx M	s	(Auto) [Auto] [8MB] [256MB] [32M] [256M]		Select which of IGFX/PEG/PCI Graphics device should be Primary Display Or select SG for Switchable Gfx.
				++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
	ersion 2.18.1263. C	opyright (C) 2	2017 American M	egatrends,

Setting	Description	
Primary Display	 Select the Graphics device which will be activated as Primary Display. Options available are Auto (default), IGFX, PEG and PCI 	
Internal Graphics	 Enables/disables the IGD. Options available are Auto (default), Disabled, and Enabled. 	
GTT Size	Select the GTT Size. • Options: 4MB , 2MB and 8MB (default).	
Apeture Size	 Select the Apeture Size. Note that above 4GB MMIO BIOS assignment is automatically enabled when selecting 2048MB aperture. To use this feature, please disable CSM support. Options: 128MB, 256MB (default), 512MB, 1024MB and 2048MB 	

DVMT Pre-Allocated	 Select the DVMT 5.0 Pre-allocated (Fixed) Graphic Memory size used by the Internal Graphic Device. ▶ 32M is the default. 	
DVMT Total Gfx Mem	Select the DVMT 5.0 Total Graphic Memory size used by the Internal Graphic Device. ► Options: 128M, 256M (default) and Max.	

5.3.1.2. SATA And RST Configuration

Chipset	Aptio Setup – AMI	
SATA And RST Configuration		Enable/Disable SATA Device.
SATA Controller(s) Aggressive LPM Support	(Enabled) [Disabled]	
Serial ATA Port 0 Port 0	Empty [Enabled]	
Serial ATA Port 1 Port 1	INTEL SSDSC2BB (120.0GB) [Enabled]	
Serial ATA Port 2 Port 2	Empty [Enabled]	
Serial ATA Port 3 Port 3	Empty [Enabled]	<pre>++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit</pre>
Version 2	.21.1278 Copyright (C) 2021	AMI

Setting	Description	
SATA Controller(s)	Enables (default) / Disables SATA device(s).	
Aggressive LPM Support	Enables / Disables(default) PCH to aggressively enter link power state.	
Serial ATA Port 0~3	SATA device information. Enables (default) / Disables the SATA port. *Available SATA ports depend on your model.	

5.3.1.3. USB Configuration

Chipset	Aptio Setup – AMI	
USB Configuration XHCI Compliance Mode XDCI Support	(Disabled) (Disabled)	Option to enable Compliance Mode. Default is to disable Compliance Mode. Change to enabled for Compliance Mode testing.
		++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Ver	rsion 2.21.1278 Copyright ((C) 2021 AMI

Setting	Description	
XHCI Disable Compliance Mode	Options to disable Compliance Mode. Default is FALSE (default) to not disable Compliance Mode. Set TRUE to disable Compliance Mode.	
xDCI Support	Enable / Disable (default) xDCI (USB OTG Device).	

5.4. Security

Main Advanced Chip	Aptio Setup – AMI set Security Boot Save & Exit	
Password Description		Set Administrator Password
Minimum length Maximum length	3 20	
Administrator Password		
▶ Secure Boot		
		++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
	Version 2.21.1278 Copyright	(C) 2021 AMI

Setting	Description	
Administrator Password	 To set up an administrator password: Select Administrator Password. An Create New Password dialog then pops up onscreen. Enter your desired password that is no less than 3 characters and no more than 20 characters. Hit [Enter] key to submit. 	
Security Boot	See 5.4.1 Security Boot on page 83.	

5.4.1. Security Boot

	Aptio Setup – AMI	
Se	ecurity	
System Mode	Setup	Secure Boot feature is Active if Secure Boot is Enabled,
Secure Boot	[Disabled] Not Active	Platform Key(PK) is enrolled and the System is in User mode. The mode change requires
Secure Boot Mode ▶ Restore Factory Keys ▶ Reset To Setup Mode	[Custom]	platform reset
▶ Key Management		
		++: Select Screen †1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
	/ersion 2.21.1278 Copyright ((C) 2021 AMI

Setting	Description	
Secure Boot	Enable/Disable (default) secure boot.	
Secure Boot Mode	Allow users to set the secure boot selector. Standard/Custome (default) mode.	
Restore Factory Keys	Force system to restore default secure boot key database.	
Reset to Setup Mode	Delete all secure boot key databases.	
Key Management	Allow users to modify secure variables and set key management page.	

5.5. Boot

Main Advanced Chipset Securi	Aptio Setup – AMI		
Main Huvanceu Chipset Securi	IY DUUL SAVE & EXIL		
Boot Configuration		Number of seconds to wait for	
Setup Prompt Timeout Bootup NumLock State	1 [0n]	setup activation key. 65535(0xFFFF) means indefinite	
Quiet Boot	[Disabled]	waiting.	
Boot Option Priorities	Diference Death Manager		
Boot Option #1	[Windows Boot Manager (P1: INTEL		
	SSDSC2BB120G6)]		
Boot Option #2	[UEFI:		
	KingstonDataTraveler		
Deat Ortica NO	3.0PMAP, Partition 1] [P1: INTEL		
Boot Option #3	SSDSC2BB120G61	++: Select Screen	
	00000200120000,	↑↓: Select Item	
		Enter: Select	
Hard Drive BBS Priorities		+/-: Change Opt.	
▶ Power Delay Function		F1: General Help F2: Previous Values	
Fower being function		F9: Optimized Defaults	
		F10: Save & Exit	
		ESC: Exit	
Version 2.21.1278 Copyright (C) 2021 AMI			

Setting	Description	
Setup Prompt Timeout	Set how long to wait for the prompt to show for entering BIOS Setup.The default setting is 1 (sec).	
	Set it to 65535 to wait indefinitely.	
Bootup NumLock State	Sets whether to enable or disable the keyboard's NumLock state when the system starts up. ▶ Options available are On (default) and Off .	
Quiet Boot	 Sets whether to display the POST (Power-on Self Tests) messages or the system manufacturer's full screen logo during booting. Select Disabled to display the normal POST message, which is the default. 	
Boot Option Priority	Set the system boot priorities.	

Hard Drive BBS Priorities	Sets the order of the legacy devices in this group. BBS means "BIOS Boot Specification".
Power Delay Function	 Power Delay Function Set the system support power delay function. ▶ Options: Enable (default): Support power delay function. Disable: Power on/off manually operated.
	 Power on delay Select the time which the system will power on. Options: Manually Operator (default), 04 Seconds, 08 Seconds and 16 Seconds.
	 Power off delay Select the time which the system will shutdown. ▶ Options: Manually Operator (default), 30 Seconds, 60 Seconds and 90 Seconds.

5.6. Save & Exit

Aptio Setup – AMI Main Advanced Chipset Security Boot Save & Exit	
Save Options Save Changes and Exit Discard Changes and Exit	Exit system setup after saving the changes.
Default Options Restore Defaults Boot Override P1: INTEL SSDSC2BB120G6 KingstonDataTraveler 3.0PMAP Windows Boot Manager (P1: INTEL SSDSC2BB120G6)	
UEFI: KingstonDataTraveler 3.0PMAP, Partition 1 Launch EFI Shell from filesystem device	++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. FI: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Version 2.21.1278 Copyright (C) 2021 AMI

Setting	Description
Save Changes and Reset	Saves the changes and quits the BIOS Setup utility.
Discard Changes and Exit	Quits the BIOS Setup utility without saving the change(s).
Restore Defaults	Restores all settings to defaults.This is a command to launch an action from the BIOS Setup utility.
Boot Override	 Boot Override presents a list in context with the boot devices in the system. P0: Select the device to boot up the system regardless of the currently configured boot priority.
	 Launch EFI Shell from filesystem device: Attempts to launch EFI Shell Application (Shell.efi) from one of the available filesystem devices.

Appendices

A: Digital I/O Setting

Digital I/O can read from or write to a line or an entire digital port, which is a collection of lines. This mechanism helps users achieve various applications such as industrial automation, customized circuit, and laboratory testing. Take the source code below that is written in C for the digital I/O application example.

Sample Codes:

```
/*_____
____*/
#include <math.h>
#include <stdio.h>
#include <dos.h>
int sioIndex = 0x2E;
int sioData = 0x2F;
int main (void)
{
       int iData;
       SioGPIOMode(0xFF00);
       delay(2000);
       SioGPIOData(0x5500);
       delay(2000);
   iData = SioGPIOStatus();
   printf(" Input : %2x \n",iData);
   delay(2000);
        SioGPIOData(0xAA00);
       delay(2000);
   iData = SioGPIOStatus();
   printf(" Input : %2x \n",iData);
   delay(2000);
      return 0;
}
void SioGPIOMode (int iMode)
       int iTemp;
   outportb(sioIndex,0x87);
                                                        /*
                                                            Enable
Super I/O */
   outportb(sioIndex,0x87);
   outportb(sioIndex,0x07);
                                                        /*
                                                            Select
```

```
logic device - GPIO */
    outportb(sioData, 0x06);
   outportb(sioIndex,0x30);
                                                               /*
                                                                     Enable
GPIO */
   outportb(sioData, 0x01);
         iTemp = iMode & 0x00FF;
    outportb(sioIndex,0xA0);
                                                               /*
                                                                       GPIO
50~57 - Output Enable */
    outportb(sioData,iTemp);
         iTemp = (iMode & 0xFF00) >> 8;
                                                               /*
    outportb(sioIndex,0xF0);
                                                                       GPIO
00~07 - Output Enable */
    outportb(sioData,iTemp);
         outportb(sioIndex,0xAA);
                                                               /* Disable
Super I/O */
}
void SioGPIOData(int iData)
{
        int iTemp;
                                                               /*
                                                                    Enable
    outportb(sioIndex,0x87);
Super I/O */
    outportb(sioIndex,0x87);
                                                               /*
                                                                     Select
    outportb(sioIndex,0x07);
logic device - GPIO */
    outportb(sioData, 0x06);
        iTemp = iData & 0x00FF;
    outportb(sioIndex,0xA1);
                                                               /*
                                                                       GPIO
50~57 - Output Data */
    outportb(sioData,iTemp);
         iTemp = (iData & 0xFF00) >> 8;
    outportb(sioIndex,0xF1);
                                                               /*
                                                                       GPIO
00~07 - Output Data */
    outportb(sioData,iTemp);
         outportb(sioIndex, 0xAA);
                                                               /* Disable
Super I/O */
}
int SioGPIOStatus()
ł
         int iStatus;
         int iTemp;
```

```
outportb(sioIndex,0x87);
                                                              /*
                                                                   Enable
Super I/O */
   outportb(sioIndex,0x87);
   outportb(sioIndex,0x07);
                                                              /*
                                                                   Select
logic device - GPIO */
   outportb(sioData, 0x06);
                                                              /*
                                                                      GPIO
        outportb(sioIndex,0xA2);
50~57 - Status */
    iTemp = inportb(sioData);
       outportb(sioIndex,0xF2);
                                                              /*
                                                                      GPIO
00~07 - Status */
    iStatus = inportb(sioData);
                                                              /* Disable
        outportb(sioIndex,0xAA);
Super I/O */
        iStatus = (iStatus<<8) + iTemp;</pre>
        return iStatus;
```

}

B: Watchdog Timer (WDT) Setting

WDT is widely used for industry application to monitor the activity of CPU. Application software depends on its requirement to trigger WDT with adequate timer setting. Before WDT time out, the functional normal system will reload the WDT. The WDT never time out for a normal system. The WDT will not be reloaded by an abnormal system, then WDT will time out and auto-reset the system to avoid abnormal operation.

This computer supports 255 levels watchdog timer by software programming I/O ports.

Below is an assembly program example to disable and load WDT.

Sample Codes:

```
/*_____
____*/
#include <math.h>
#include <stdio.h>
#include <dos.h>
int main(void)
ł
      int iCount;
      printf("WDT Times ( 1 \sim 255 ) : \0");
      scanf("%d",&iCount);
      printf("\n");
      SioWDTStart(iCount);
      while(1)
       {
            iCount = SioWDTCount();
            printf("\r Counts : %d ",iCount);
            sleep(1);
       }
      return 0;
}
void SioWDTStart(int iCount)
                                               /* Enable
      outportb(sioIndex, 0x87);
Super I/O */
```

<pre>outportb(sioIndex, 0x87);</pre>		
<pre>outportb(sioIndex, 0x07); logic device - WDT */</pre>	/*	Select
<pre>outportb(sioData, 0x07);</pre>		
<pre>outportb(sioIndex, 0x30); WDT */</pre>	/*	Enable
<pre>outportb(sioData, 0x01);</pre>		
outportb(sioIndex, 0xFA); WDTRST# Output */	/*	Enable
<pre>outportb(sioData, 0x01);</pre>		
<pre>outportb(sioIndex, 0xF6); Timeout value */</pre>	/*	Set WDT
outportb(sioData, iCount);		
outportb(sioIndex, 0xF5); Configure and Enable WDT timer, Start countdown */ outportb(sioData, 0x32);	/*	Set
<pre>outportb(sioIndex, 0xAA); Super I/O */</pre>	/*	Disable
}		
<pre>void SioWDTStop(void) {</pre>		
outportb(sioIndex, 0x87); Super I/O */	/*	Enable
<pre>outportb(sioIndex, 0x87);</pre>		
<pre>outportb(sioIndex, 0x07); logic device - WDT */</pre>	/*	Select
outportb(sioData, 0x07);		
outportb(sioIndex, 0xF5); WDT timer, stop countdown */	/*	Disable
<pre>outportb(sioData, 0x12);</pre>		
outportb(sioIndex, 0xAA); Super I/O */ }	/*	Disable
<pre>void SioWDTClear(int iCount) {</pre>		
utportb(sioIndex, 0x87); Super I/O */	/*	Enable
outportb(sioIndex, 0x87);		
<pre>outportb(sioIndex, 0x07);</pre>	/*	Select

<pre>logic device - WDT */ outportb(sioData, 0x07);</pre>		
<pre>outportb(sioIndex, 0xF6); Timeout Value */</pre>	/*	Reset WDT
<pre>outportb(sioData, iCount);</pre>		
<pre>outportb(sioIndex, 0xAA); Super I/O */ }</pre>	/*	Disable
<pre>int SioWDTCount(void) { int iData;</pre>		
<pre>outportb(sioIndex, 0x87); Super I/0 */ outportb(sioIndex, 0x87);</pre>	/*	Enable
<pre>outportb(sioIndex, 0x07); logic device - WDT */ outportb(sioData, 0x07);</pre>	/*	Select
<pre>outportb(sioIndex, 0xF6); of timer */ iData = inportb(sioData);</pre>	/*	Get count
<pre>outportb(sioIndex, 0xAA); Super I/O */</pre>	/*	Disable
return iData; }		